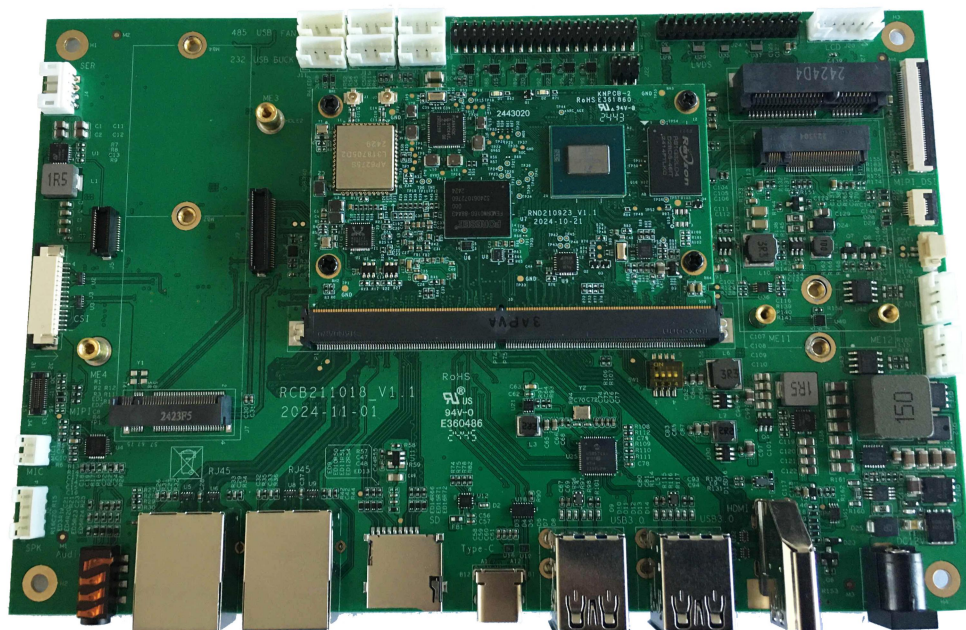


i.MX 8M Plus SMARC Development Board

SPECIFICATION

MODEL: DB820P



Revision History

VERSION	DATE	BOARD ID	PAGE	DESCRIPTION	AUTHOR
V1.0	22/7/16	RCB211018	14		
V1.1	2024/11/23	RCB211018_V1.1	20		

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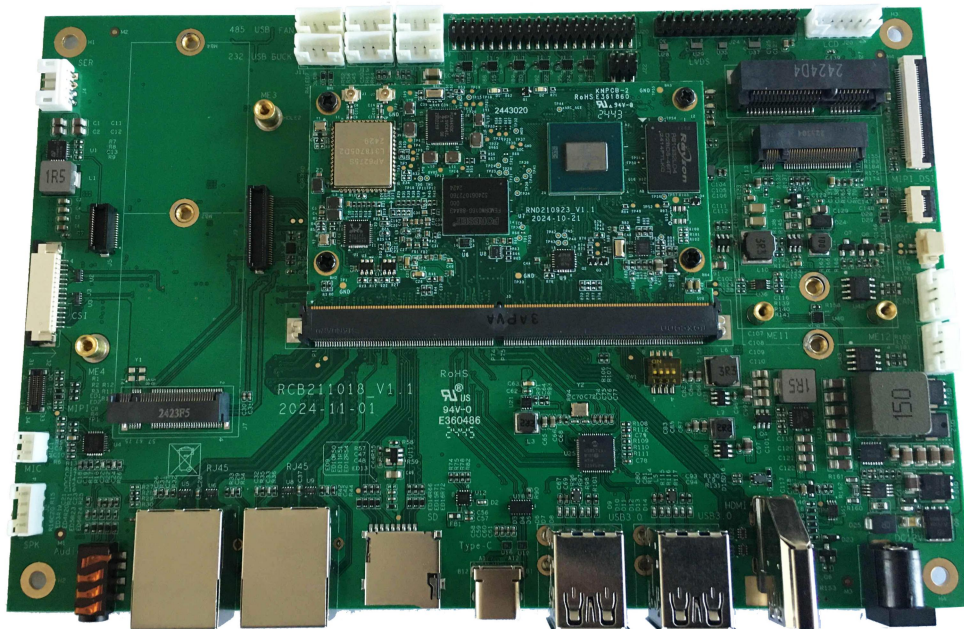
1. General Description

The i.MX 8M Plus SMARC development board DB820P includes the SOM-iMX8MP-SMARC core board and the CBD-iMX8MP-SMARC carrier board. The SOM-iMX8MP-SMARC core board is based on the high-performance i.MX 8M Plus SoC, is the NXP first integrated transmission nerve processing unit (NPU) product, operating rate of up to 2.3 TOPS, focus on machine learning and vision, multimedia, and industrial automation with high reliability. The CBD-iMX8MP-SMARC carrier plate can be used to fully validate the functionality and performance of the i.MX 8M Plus chip. At the same time, it can also build a rapid prototype of application scenarios, which can be widely used in machine learning and artificial intelligence, NPU vision system, advanced multimedia and industrial automation, etc.

- i.MX 8M Plus SoC, using a 14-nm FET process technique.
- Quad-core 64-bit ARM Cortex A53 processor + Cortex-M7.
- Integrated neural network processing unit (NPU) with a performance of 2.3 TOPS.
- Efficient H.265/H.264/VP9 video decoding capability, with support for up to 4K resolution.
- Support MIPI-DSI, MIPI-CSI, HDMI, LVDS and other display and camera interfaces.
- 2 x Gigabit network / scalable 4G & 5G / multiple M.2 interface, etc.

2. Product Overview

Below picture is for reference only, please prevail in kind.



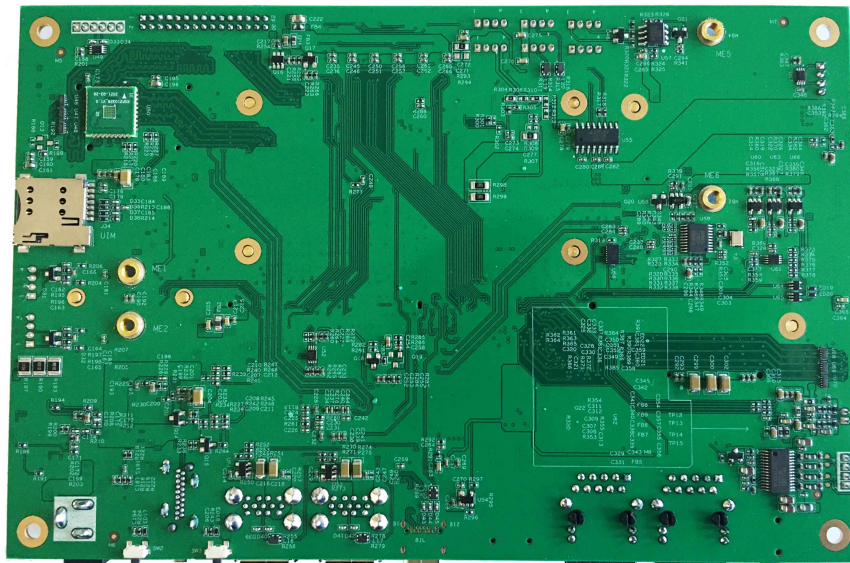


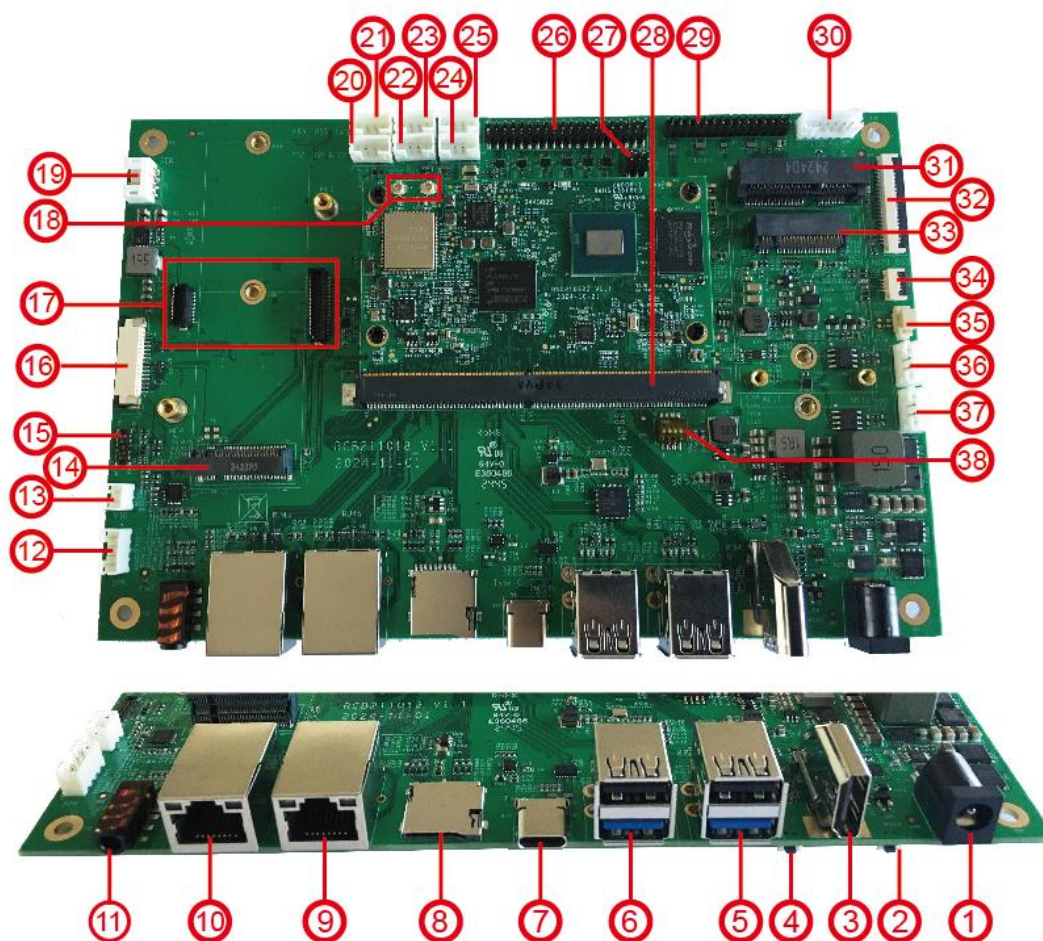
Figure 1 is a detailed PCB layout for the RC8211018. The layout is rectangular, with overall dimensions of 190.00mm in width and 125.00mm in height. A central section of the layout is defined by dimensions of 178.00mm in width and 113.00mm in height. The layout includes numerous components, such as integrated circuits (ICs), capacitors, and connectors, arranged in a structured manner. A scale bar in the bottom right corner indicates a length of 3.00mm. The layout is labeled with various component identifiers and dimensions.

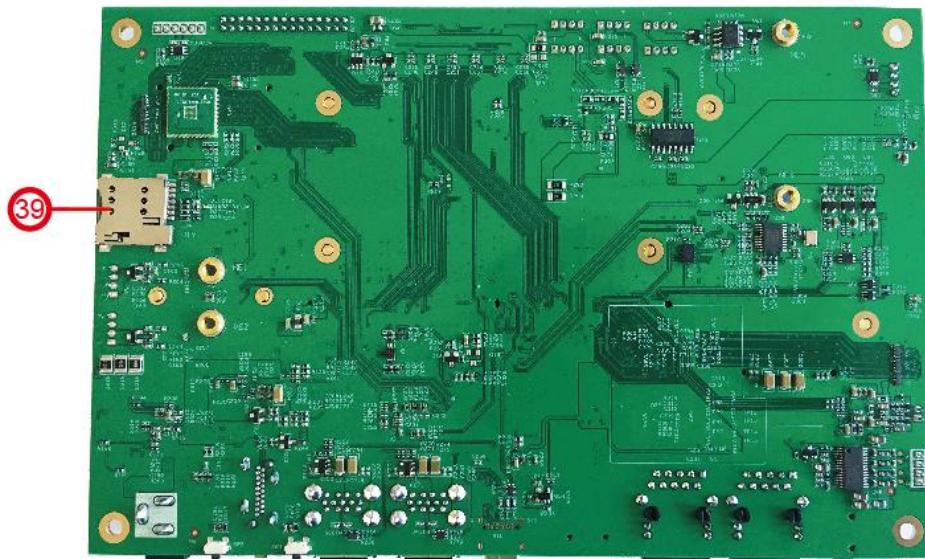
3. Features

CHIPSET	NXP iMX8M Plus	
MARKET AREA	Global	
SMARC-Module	OS	Yocto(Linux)/Android 10
	SOC	4 x Cortex-A53, up to 1.8GHz&1 x Cortex-M7, up to 800MHz
	GPU	GC7000UL with OpenCL and Vulkan support Supports OpenGL ES 1.1, 2.0, 3.0, OpenCL 1.2, Vulkan
	NPU	2.3 TOP/s Neural Network performance
	LPDDR4	4GB (1G-8G optional)
	EMMC	16GB eMMC5.1(8-128GB Optional)
	Wi-Fi/BT	Wifi2.4G+5G +BT 5.0
Development board Interfaces	SMARC	SMARC V2.1 Compatible with SMARC modules CPU Modules. (82 x 50mm)
	External I/O Connector	1 x Power Key (SW2) 1 x Reset Key (SW3) 1 x DC Jack (J29) 2 x USB 2.0 Type A (J21 J23) 2 x USB 3.0 Type A (J21 J23) 1 x USB Type C (J18) 2 x Giga Ethernet (J10 & J8) 1 x Headphone (J6) 1 x Micro SD Socket(J15) 1 x Micro SIM Socket (J34) 1 x HDMI Out (J25)
	Internal I/O Connector	1 x RS232 4P Header (J11) 1 x RS485 4P Header (J12) 1 x SW1 for System boot mode switch 1 x Expanded Connector 2x20 P Header (J20) 1 x B2B Connector for AI module 60Pin (J9) 1 x B2B Connector for AI module power supply 30Pin (J5) 1 x Speaker (Left/Right Channel) 4P Header (J2) 2 x USB2.0 4P Header (J13 J14) 1 x Mic 2P Header (MIC1) 1 x RTC-Battery (JBAT1) 1 x FAN 4P Header with FAN PWM (J16) 1 x LCD Backlight 6P Header (J28) 1 x LVDS Panel Power Switch (J22) 1 x LVDS Screen Connector 2x15P (J24) 1 x M.2 Key B for 4G/5G (J26) 1 x Mini PCIe for 4G (J27) 1 x M.2 Key M for Storage (J7) 1 x A53 Core Debug connector (UART) (J4) 1 x I2C Touch Screen connector (J30)

		1 x MIPI DSI connector for MIPI Panel (J33) 1 x MIPI CSI connector for MIPI Camera 2 lanes (J3) 1 x MIPI CSI connector for MIPI Camera 4 lanes (J1) 2 x CAN 4P Header (J31 & J32)
	DC-IN	12V2A
Dimensions	190*125mm	

4. Connectors list



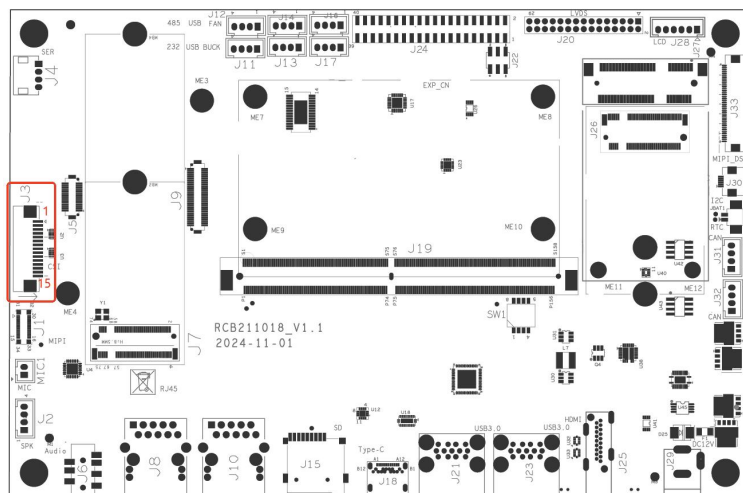


No.	Label	Function	Note
1	J29	DC Jack connector	
2	SW2	Power Key	
3	J25	HDMI Out	HDMI 2.0a Type-A
4	SW3	Reset Key	
5	J23	USB 3.0 Type A USB 2.0 Type A	
6	J21	USB 3.0 Type A USB 2.0 Type A	
7	J18	USB Type C	
8	J15	Micro SD Socket	
9	J10	Giga Ethernet	
10	J8	Giga Ethernet	
11	J6	Headphone Jack connector	
12	J2	Speaker out 4P Header	1 x 4P Header , pitch 2.0mm
13	MIC1	Microphone input	1 x 2P Header , pitch 2.0mm
14	J7	M.2 Key M for Storage or AI module	
15	J1	MIPI CSI connector for MIPI Camera 4 lanes	
16	J3	MIPI CSI connector for MIPI Camera 2 lanes	
17	J5+J9	B2B Connector for AI module 60Pin (J9) B2B Connector for AI module power supply 30Pin (J5)	
18	IPEX	WiFi antenna	
19	J4	A53 Core Debug connector (UART)	1 x 4P Header , pitch 2.0mm
20	J11	RS232 4P Header	1 x 4P Header , pitch 2.0mm
21	J12	RS485 4P Header	1 x 4P Header , pitch 2.0mm

22	J13	USB2.0 4P Header	1 x 4P Header , pitch 2.0mm
23	J14	USB2.0 4P Header	1 x 4P Header , pitch 2.0mm
24	J17	BUCK 4P Header	1 x 4P Header , pitch 2.0mm
25	J16	FAN 4P Header with FAN PWM	1 x 4P Header , pitch 2.0mm
26	J20	Expanded Connector 2x15P Header	2 x 15P header, pitch 2.0mm
27	J22	LCD Backlight power supply select	2 x 3P header, pitch 2.0mm
28	J19	SMARC connector	
29	J24	LVDS Screen Connector 2x15P	2 x 15P header, pitch 2.0mm
30	J28	LCD Backlight 6P Header	1 x 6P Header , pitch 2.0mm
31	J27	Mini PCIe for 4G/5G	
32	J33	MIPI DSI connector for MIPI Panel	1 x 30 wafer, pitch 0.50mm
33	J26	M.2 Key B for 4G/5G	
34	J30	I2C Touch Screen connector	1 x 6P wafer, pitch 0.50mm
35	JBAT1	RTC battery	
36	J31	CAN 4P Header	1 x 4P Header , pitch 2.0mm
37	J32	CAN 4P Header	1 x 4P Header , pitch 2.0mm
38	SW1	System boot mode switch	
39	J34	Micro SIM Socket	

5. Connectors Pin Outs

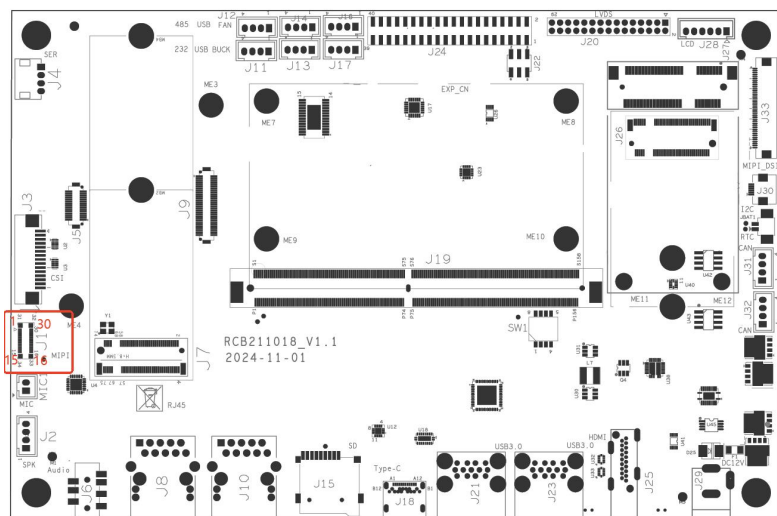
5.1 J3: MIPI CSI connector for MIPI Camera 2 lanes



J3 (FPC_15Pin_1.0mm)

Pin	Function	Pin	Function
1	GND	2	MIPI_CSIO_RX0-
3	MIPI_CSIO_RX0+	4	GND
5	MIPI_CSIO_RX1-	6	MIPI_CSIO_RX1+
7	GND	8	MIPI_CSIO_CK-
9	MIPI_CSIO_CK+	10	GND
11	MIPI_CSIO_PWR	12	MIPI_CSIO_MCLK
13	MIPI_CSIO_SCL	14	MIPI_CSIO_SDA
15	VDD_3V3		

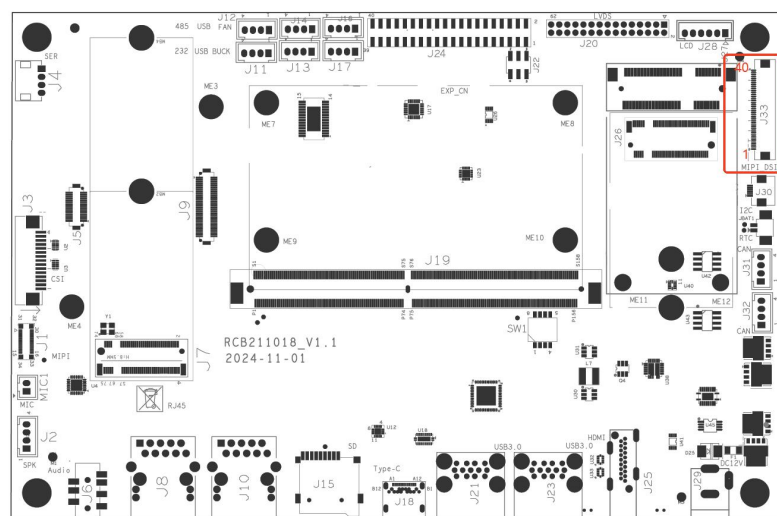
5.2 J1: MIPI CSI connector for MIPI Camera 4 lanes



J1(OK-23GM030-04)

Pin	Function	Pin	Function
1	MIPI_CSI1_RX3-	30	VCC12_DVP
2	MIPI_CSI1_RX3+	29	VCC18_DVP
3	GND	28	GND
4	MIPI_CSI1_RX1-	27	MIPI_CSI1_SDA
5	MIPI_CSI1_RX1+	26	MIPI_CSI1_SCL
6	GND	25	GND
7	MIPI_CSI1_CK-	24	MIPI_CSI1_MCLK
8	MIPI_CSI1_CK+	23	GND
9	GND	22	VCC12_DVP
10	MIPI_CSI1_RX0-	21	GND
11	MIPI_CSI1_RX0+	20	MIPI_CSI1_RST
12	GND	19	NC(TP1)
13	MIPI_CSI1_RX2-	18	GND
14	MIPI_CSI1_RX2+	17	AVDD28_DVP
15	GND	16	GND

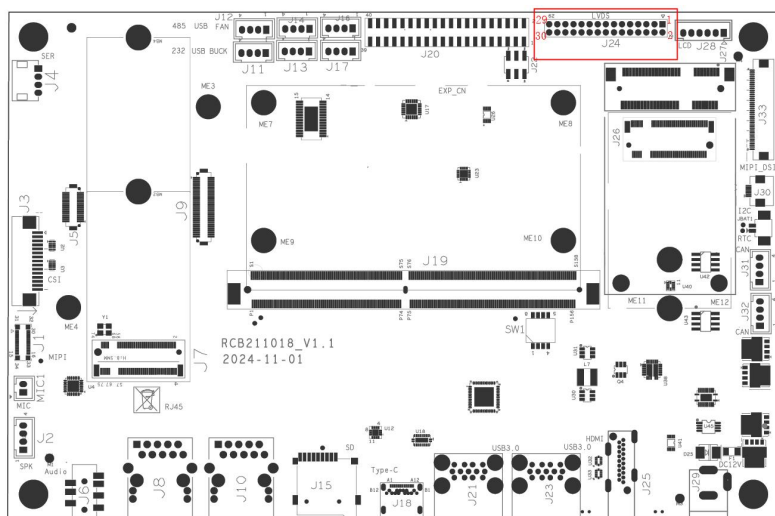
5.3 J33: MIPI DSI connector for MIPI Panel



J33(FPC_40Pin_0.5mm)

Pin	Function	Pin	Function
1	NC1	21	DSI_DATA3_P
2	VCC_LCD0	22	GND
3	VDD_1V8/3V3	23	NC
4	GND	24	NC
5	MIPI_DSI_nRST	25	GND
6	NC	26	NC
7	GND	27	PWM_OUT
8	DSI_DATA0_N	28	NC
9	DSI_DATA0_P	29	NC
10	GND	30	GND
11	DSI_DATA1_N	31	VCC1_LED-
12	DSI_DATA1_P	32	VCC1_LED-
13	GND	33	NC
14	DSI_CLOCK_N	34	NC
15	DSI_CLOCK_P	35	NC
16	GND	36	NC
17	DSI_DATA2_N	37	NC
18	DSI_DATA2_P	38	NC
19	GND	39	VCC1_LED+
20	DSI_DATA3_N	40	VCC1_LED+

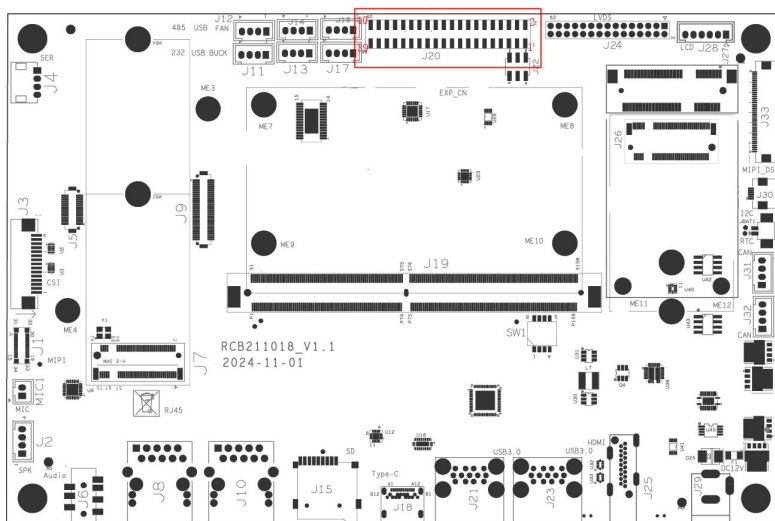
5.4 J24: LVDS Screen Connector 2x15P



J24(2*15Pin 2.0mm)

Pin	Function	Pin	Function
1	PANELVCC	2	PANELVCC
3	PANELVCC	4	GND
5	GND	6	GND
7	LVDS0_TX0_N	8	LVDS0_TX0_P
9	LVDS0_TX1_N	10	LVDS0_TX1_P
11	LVDS0_TX2_N	12	LVDS0_TX2_P
13	GND	14	GND
15	LVDS0_CLK_N	16	LVDS0_CLK_P
17	LVDS0_TX3_N	18	LVDS0_TX3_P
19	LVDS1_TX0_N	20	LVDS1_TX0_P
21	LVDS1_TX1_N	22	LVDS1_TX1_P
23	LVDS1_TX2_N	24	LVDS1_TX2_P
25	GND	26	GND
27	LVDS1_CLK_N	28	LVDS1_CLK_P
29	LVDS1_TX3_N	30	LVDS1_TX3_P

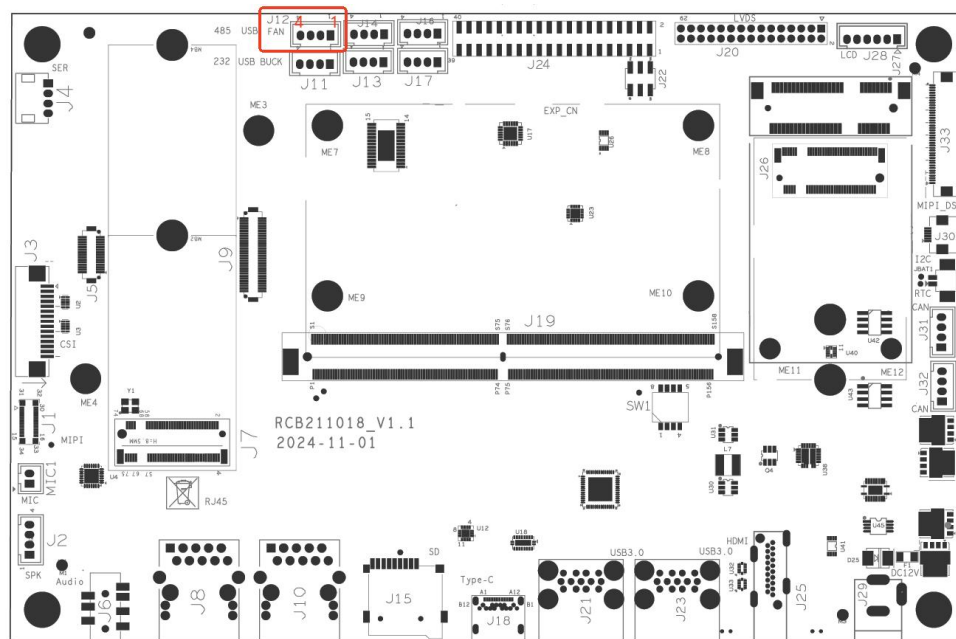
5.5 J20: Expanded Connector 2x20 P Header



J20(2*20Pin 2.0mm)

Pin	Function	Pin	Function
1	VEXP_3V3	2	VEXP_5V
3	I2C3_SDA_3V3	4	VEXP_5V
5	I2C3_SCL_3V3	6	GND
7	UART0_CTS_3V3	8	UART0_TXD_3V3
9	GND	10	UART0_RXD_3V3
11	UART0_RTS_3V3	12	UART3_TXD_3V3
13	ESPI_IO_0_3V3	14	GND
15	ESPI_IO_1_3V3	16	UART3_RXD_3V3
17	VEXP_3V3	18	ESPI_ALERT0_3V3
19	ECSPI2_MOSI_3V3	20	GND
21	ECSPI2_MISO_3V3	22	ECSPI_CS0_3V3
23	ECSPI2_SCLK_3V3	24	ECSPI2_SS0_3V3
25	GND	26	ECSPI_CS1_3V3
27	I2C5_SDA_3V3	28	I2C5_SCL_3V3
29	ESPI_IO_2_3V3	30	GND
31	ESPI_IO_3_3V3	32	GPIO9/PWM2_3V3
33	ESPI_CK_3V3	34	GND
35	PDM_STREAM_3	36	PDM_STREAM_2
37	PDM_STREAM_1	38	PDM_STREAM_0
39	GND	40	PDM_CLK

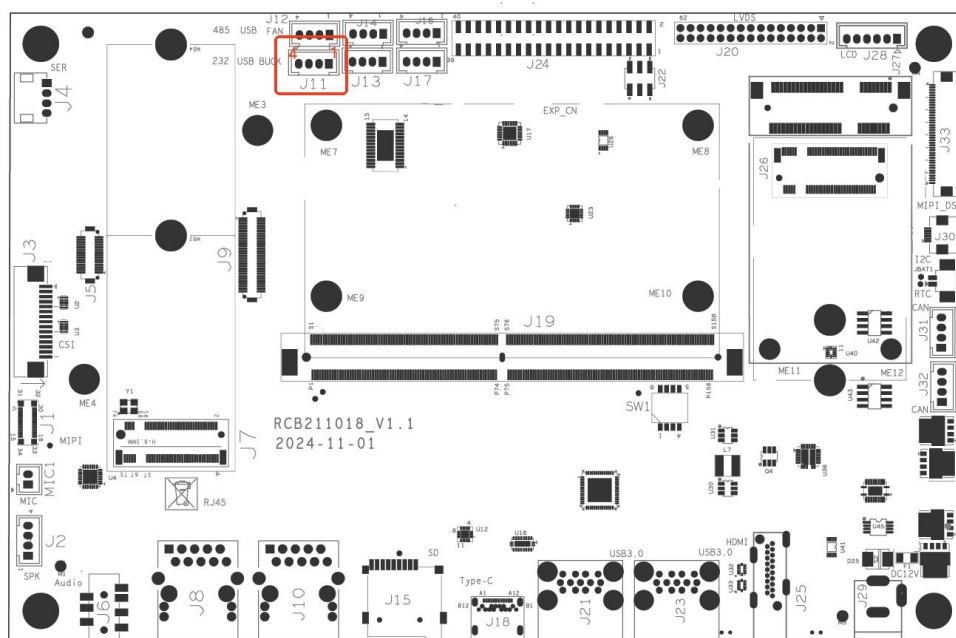
5.6 J12: RS485 4P Header



J12

Pin	Function
1	RS485_1_B
2	GND
3	RS485_1_A
4	NC

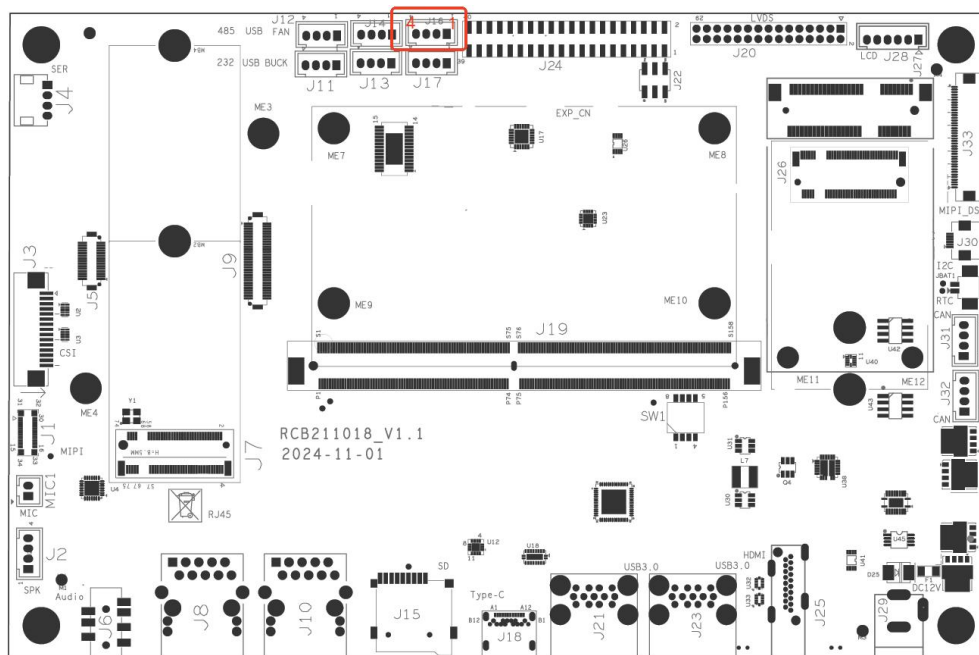
5.7 J11: RS232 4P Header



J11

Pin	Function
1	RS232_RX
2	GND
3	RS232_TX
4	NC

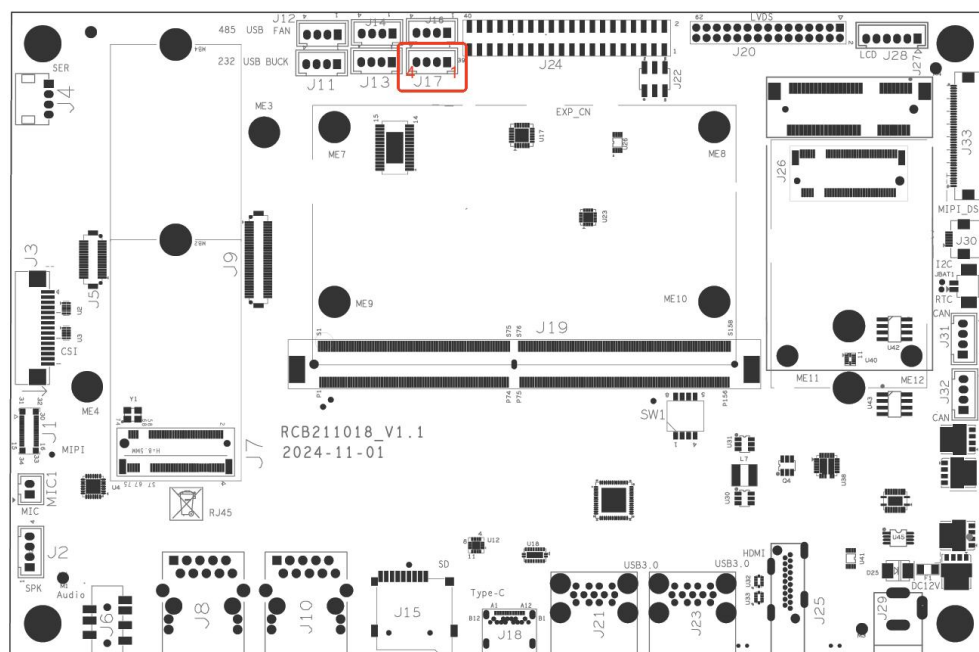
5.8 J16: FAN 4P Header



J16

Pin	Function
1	GND
2	VDD_5V
3	FAN_TACH
4	FAN_PWM

5.9 J17:BUCK



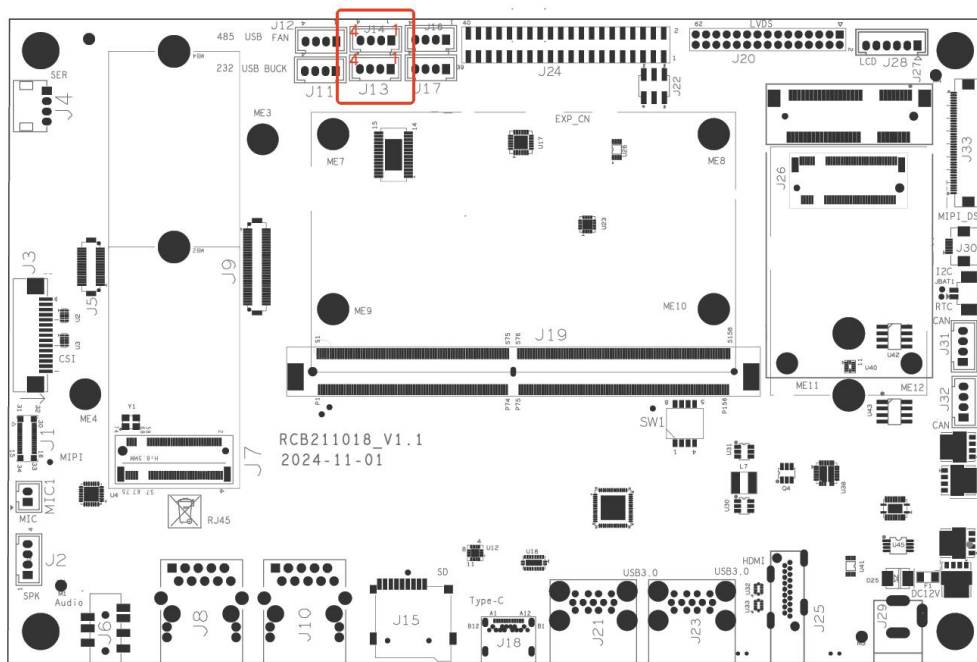
J17

Pin	Function
1	VCC BUCK
2	VCC BUCK
3	CA1/LED1
4	CA3/LED3

J28	
Pin	Function
1	GND
2	GND
3	LVDS_BL_PWM_3V3
4	LVDS_BL_EN_3V3
5	VCC_BUCK
6	VCC_BUCK

J28	
Pin	Function
1-2	VCC_BUCK(12V)
3-4	VDD_5V
5-6	VDD_3V3

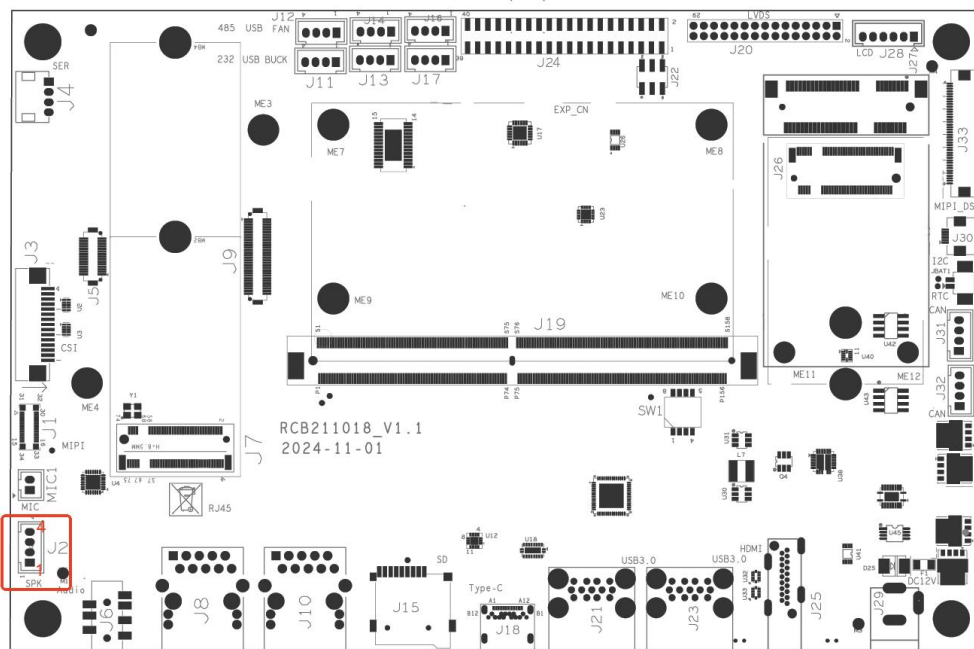
5.12 J13&J14: USB 4P Header



J13	
Pin	Function
1	VCC_5V
2	USB4_HUB_DM
3	USB4_HUB_DP
4	GND

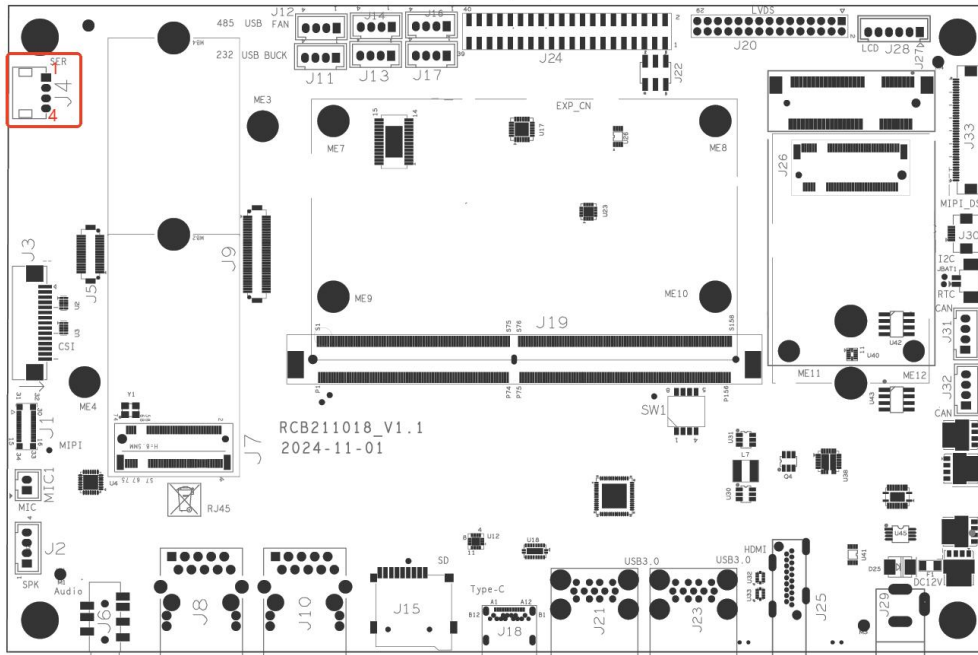
J14	
Pin	Function
1	VCC_5V
2	USB3_HUB_DM
3	USB3_HUB_DP
4	GND

5.13 J2: Speaker (Left/Right Channel) 4P Header



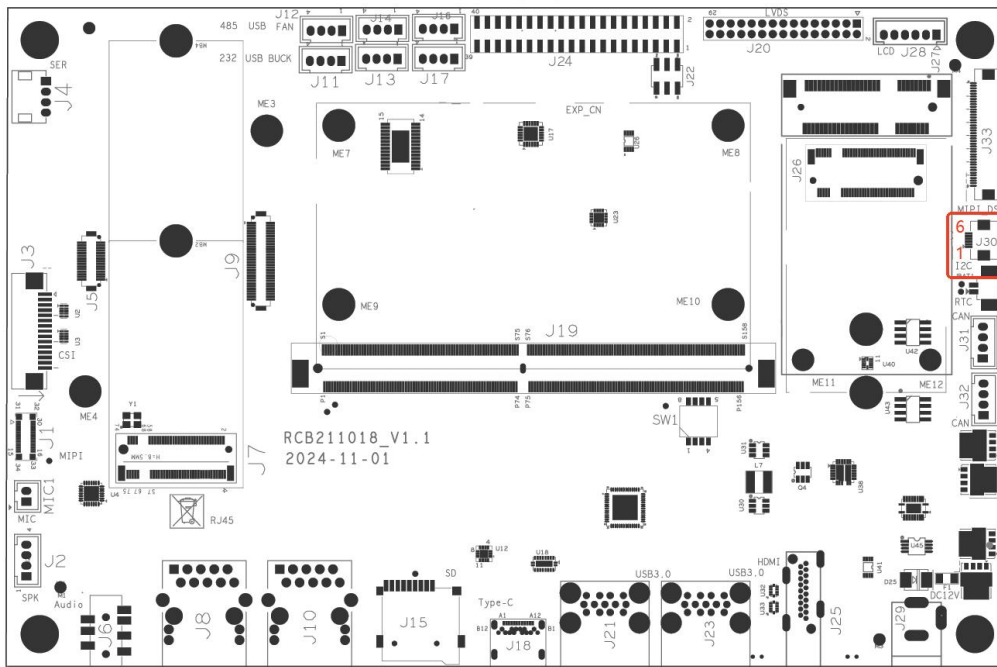
J2	
Pin	Function
1	L_SPK-
2	L_SPK+
3	R_SPK-
4	R_SPK+

5.14 J4: A53 Core Debug connector



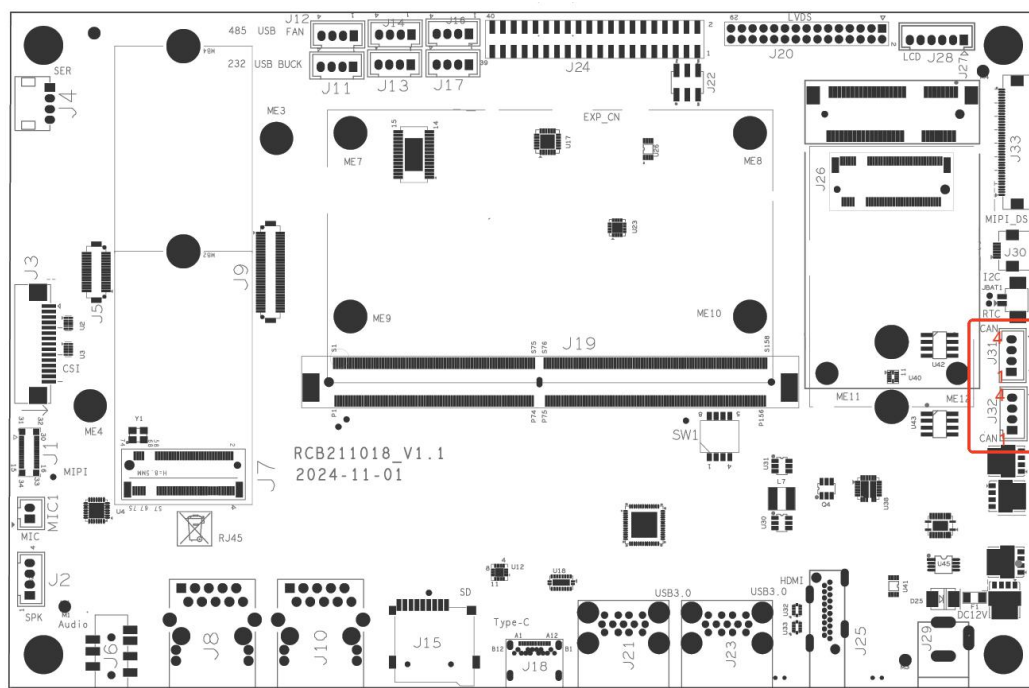
J4	
Pin	Function
1	UART2_RXD_3V3
2	GND
3	UART2_TXD_3V3
4	NC

5.15 J30: I2C Touch Screen connector



J30(FPC 6Pin 0.5mm)	
Pin	Function
1	TP_I2C_SCK
2	TP_I2C_SDA
3	TP_VCC_3V3
4	TP_nRST_3V3
5	TP_INT_3V3
6	GND

5.16 J31 & J32: CAN 4P Header



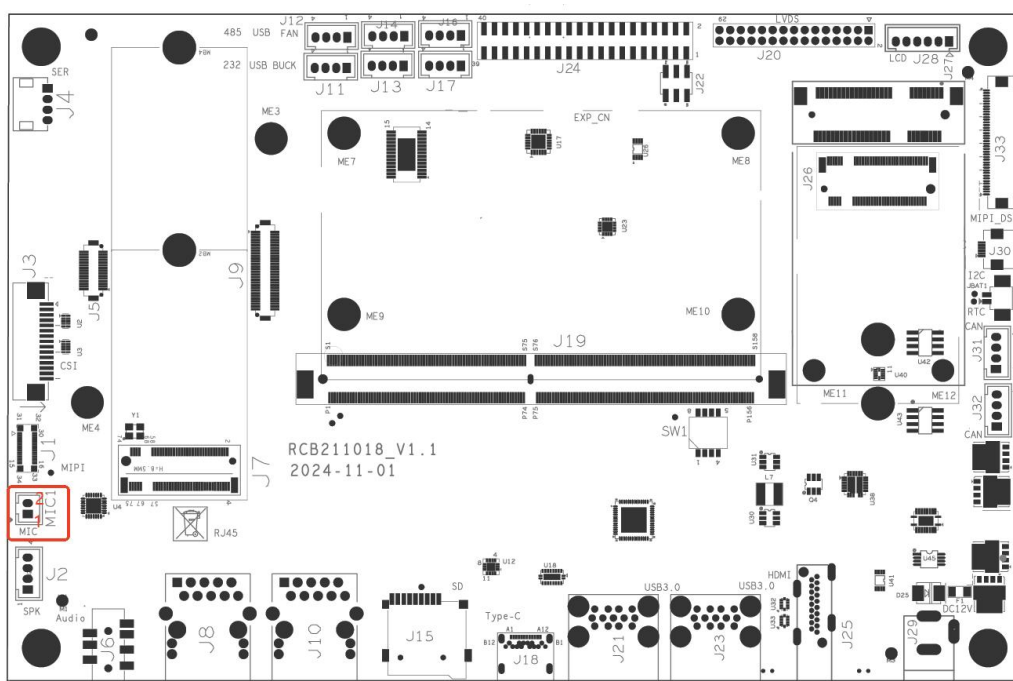
J31

Pin	Function
1	CAN1_L
2	GND
3	CAN1_H
4	NC

J32

Pin	Function
1	CAN0_L
2	GND
3	CAN0_H
4	NC

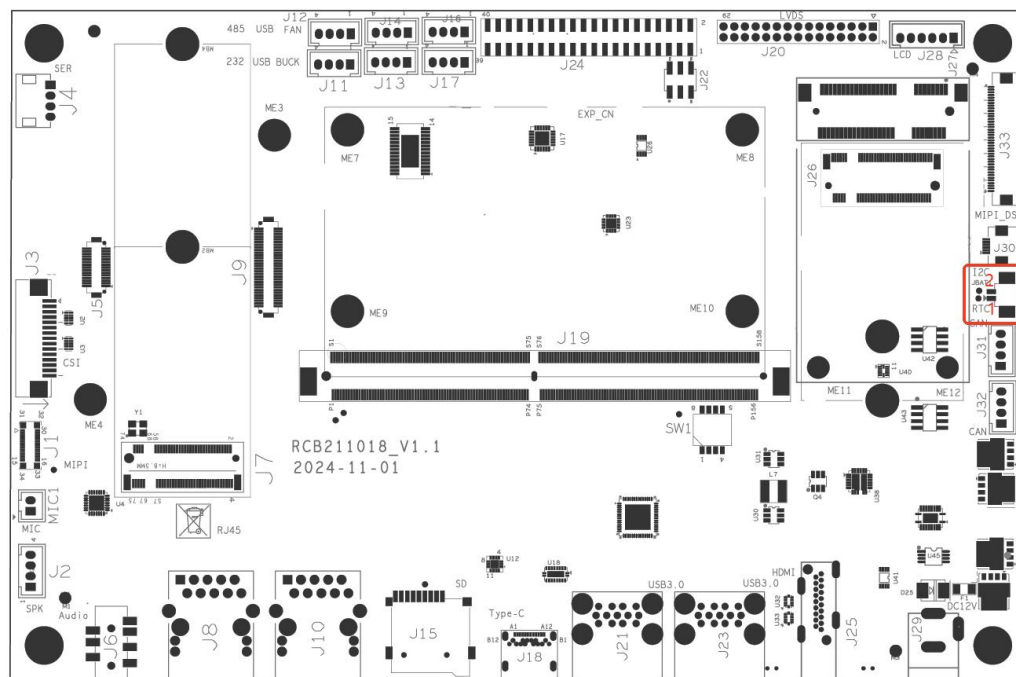
5.17 MIC1:Microphone Input Header



MIC1

Pin	Function
1	MIC2P
2	MIC2N

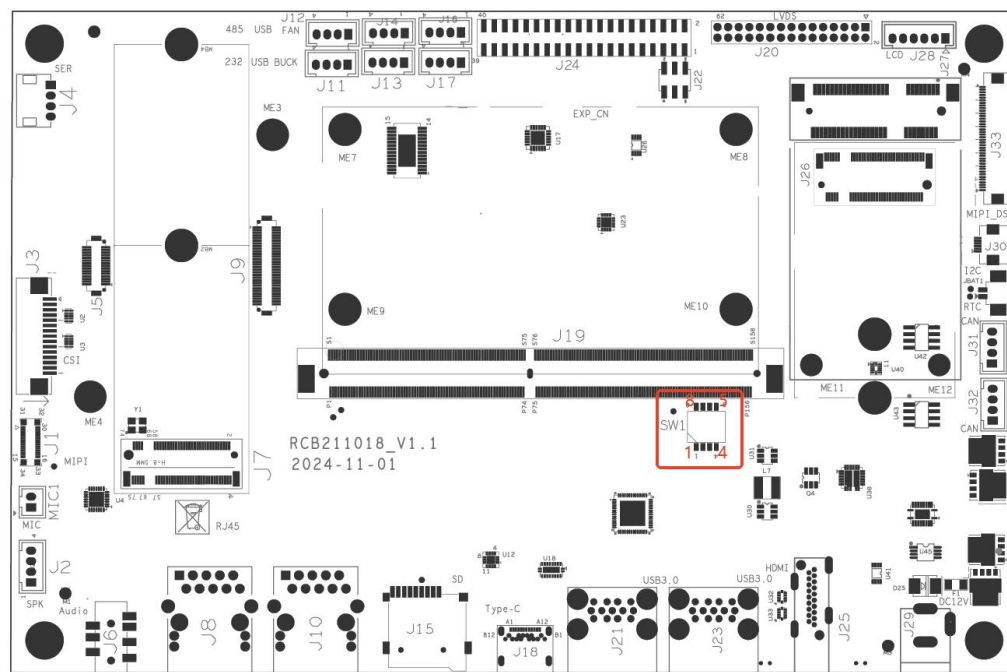
5.18 JBAT1:RTC Battery Header



JBAT1

Pin	Function
1	VDD_RTC
2	GND

5.19 SW1: System boot mode switch

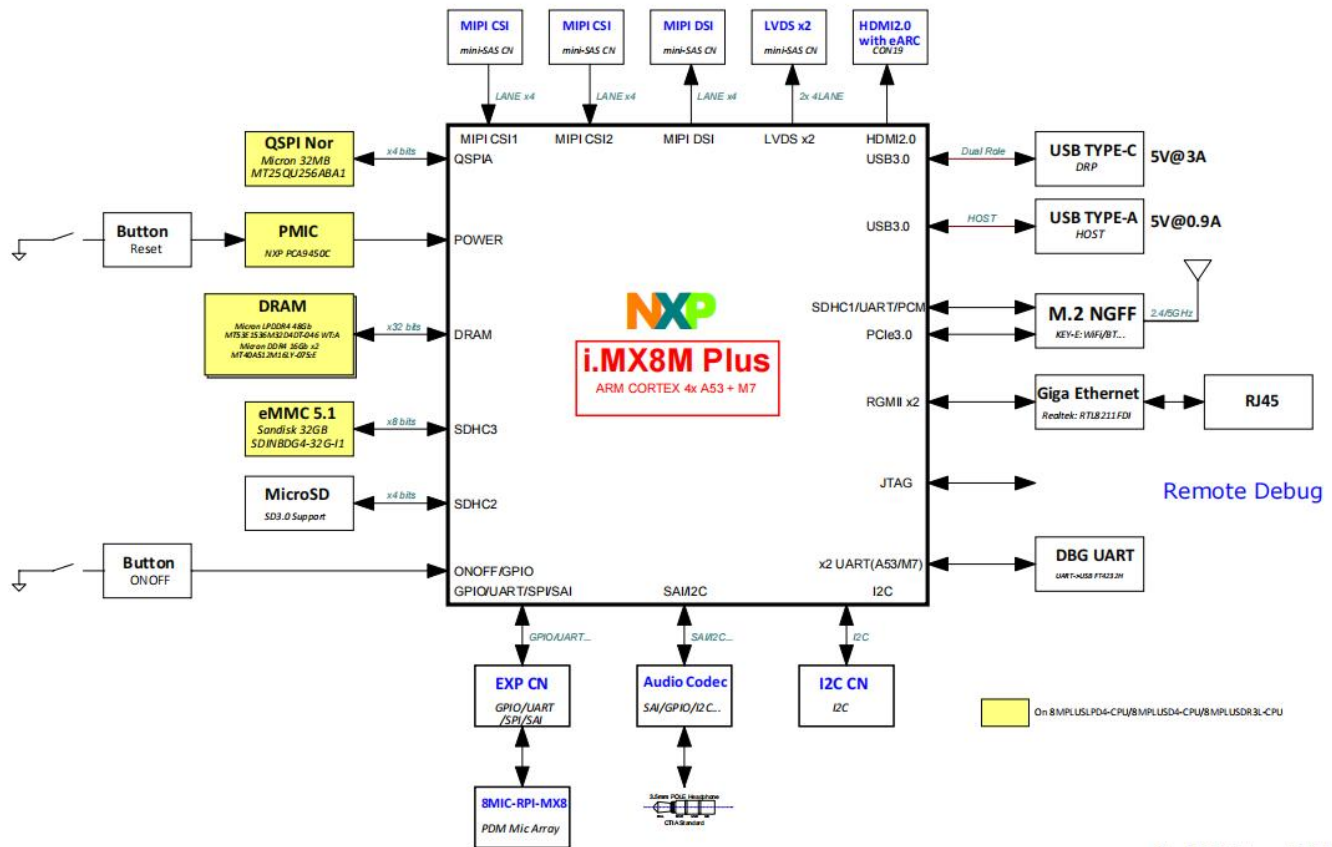


SW1

Pin	Function
1	BOOT_SEL0
2	BOOT_SEL1
3	BOOT_SEL2
4	BOOT_SEL3
5	GND
6	GND
7	GND
8	GND

BOOT_SEL3	BOOT_SEL2	BOOT_SEL1	BOOT_SEL0	Boot Modes
OFF	OFF	ON	OFF	USDHC3 (eMMC boot only, SD3 8-bit)
OFF	OFF	OFF	OFF	USB Serial Download

6. System Block Diagram



7. Support Formats

Video Decode

- 1080p60 HEVC/H.265 Main, Main 10 (up to level 5.1)
- 1080p60 VP9 Profile 0, 2
- 1080p60 VP8
- 1080p60 AVC/H.264 Baseline, Main, High decoder

Video Encode

- 1080p60 AVC/H.264 encoder
- 1080p60 HEVC/H.265 encoder

Image Sensor Processor (ISP)

375 Mpixel/s HDR ISP supporting configurations, such as 12MP@30fps, 4kp45, or 2x 1080p80

8. Precautions For Use

Relative humidity: ≤80% .

Operation temperature: Commercial field: 0~85℃; Industrial field: -40~85℃.

Keep the Board away from static electricity.

Keep the Board away from water and other liquid.

Don't use long connect wires which may affect performance and image quality.

More Help

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Official Mall: <https://shop.geniatech.com>